

Enhanced power switch

Not recommended for new design

Features

- 80 mΩ high-side MOSFET switch
- 500 mA continuous current per channel
- Thermal and short-circuit protection with overcurrent logic output
- Operating range from 2.7 V to 5.5 V
- CMOS- and TTL-compatible enable inputs
- 10 ms OC_N fault-blanking
- 2.5 ms typical rise time
- Undervoltage lock out
- 10 µA maximum standby supply current
- Ambient temperature range, -40 °C to 85 °C
- Fault-blanking

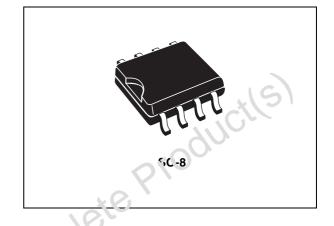


Table 1. Device summary

Order code	Package	Packaging
ST2042BD ⁽¹⁾	SO-8	Tube (50 parts per tube, 40 tube per box)
ST2042BD:R ⁽¹⁾	SO-8	Tape and reel (2500 parts per reel)

^{1.} Not recommended for new design (refer to STMPS2242MTR). Contact ST sales office for availability.

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ST2042 Description

1 Description

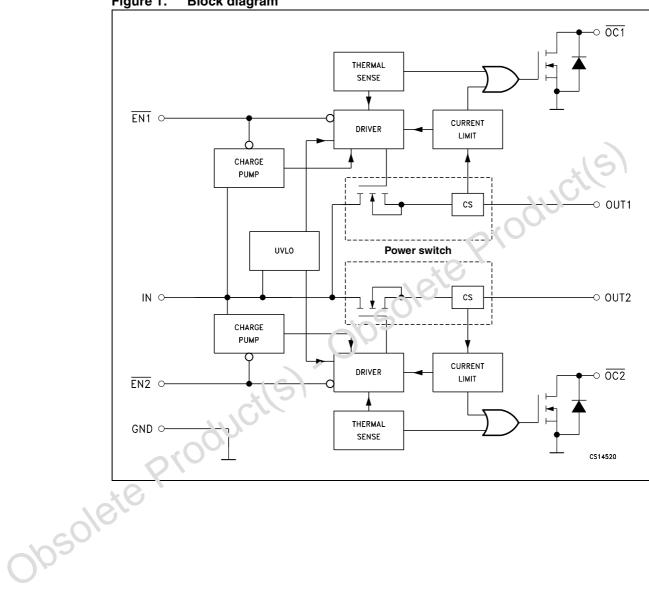
The ST2042 power distribution switches is intended for application where heavy capacitive loads and short-circuits are likely to be encountered. These devices incorporate $80~m\Omega$ N-channel MOSFET high-side power switches for power-distribution systems that require multiple powers switches in a single package. Each switch is controlled by an independent logic enable input. Gate drive is provided by an internal charge pump designed to control the power-switch rise times and fall times to minimize current surges during switching. The charge pump requires no external components and allows operation from supplies as low as 2.7 V. When the output load exceeds the current-limit threshold or a short is present, these devices limit the output current to a safe level by switching into a constant-current mode, pulling the overcurrent (OCx) logic output low.

A 10 ms deglitching circuit provides fault-blanking feature, preventing the OC_N bit to be asserted during hot-insertion or short spikes of overcurrent conditions. When continuous heavy overloads and short circuits increase the power dissipation in the switch, causing the junction temperature to rise, a thermal protection circuit shuts off the switch or prevent damage. Recovery from a thermal shutdown is automatic once the derice has cooled sufficiently. Internal circuitry ensures the switch remains off until volid input voltage is present. These power-distribution switches are designed to current limit at 0.9 A.

Block diagram ST2042

Block diagram 2





ST2042 Pin connections

3 Pin connections

Figure 2. Pin connections (top view)

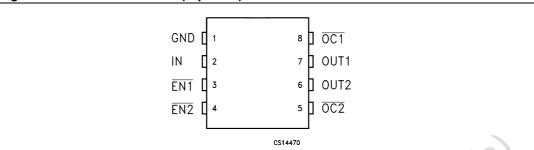


Table 2. Pin functions

	Pin	Symbol	Description
	1	GND	Ground
	2	IN	Input voltage
	3	EN1	Enable input. Log c ov turns on power switch IN-OUT1.
	4	EN2	Enable input. Logic low turns on power switch IN-OUT2.
	5	OC2	Overcurent. Logic output active low IN-OUT2.
	6	OUT2	Pr wer switch output
	7	OUT1	Power switch output
	8	CC1	Overcurrent. Logic output active low IN-OUT2
Obsole	e Prodi	CI	

Electrical ratings ST2042

Electrical ratings 4

Absolute maximum ratings 4.1

Stressing the device above the rating listed in the "Absolute Maximum Ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics™ SURE program and other relevant quality documents.

Table 3. **Absolute maximum ratings**

Symbol	Parameter	Value	Unit
VI	Input voltage range ⁽¹⁾	-0.3 - 6	V
V _O	Output voltage range ⁽¹⁾	-0.3 - (V ₁ · υ.3)	V
V _{IENX}	EN Input voltage range	-0.3 to 6	V
Io	Continuous output current	Internally limited	
ESD	Electrostatic discharge	2	kV
TJ	Junction operating temperature	-40 to 125	°C

^{1.} All voltages are referred to GND.

4.2 **Recommended operating conditions**

Table 4. Recommended operating conditions

	Symbol	Parameter	Min.	Тур.	Max.	Unit
	V	יייטעt voltage range ⁽¹⁾	2.7		5.5	V
	Vo	Output voltage range ⁽¹⁾	0		5.5	V
10	lo	Continuous output current (per switch)	0		500	mA
3/050/C	1. All voltage	s are referred to GND.				

Electrical characteristics 5

 V_I = 5.5 V, I_O = rated current, $V_{\overline{IEN}}$ = 0 V, T_J = 25 °C, unless otherwise specified (See *Note 1* on page 8).

Table 5. Power switch electrical characteristics

Symbol	Parameter	To	est conditions	Min.	Тур.	Max.	Unit
		V _I = 5 V	I _O = 0.5 A		80	100	
		V _I = 5 V	$I_{O} = 0.5 \text{ A}, T_{J} = 85 ^{\circ}\text{C}$		90	120	
R _{DS(on)} Static drain-source ON-state resistance	V _I = 5 V	I _O = 0.5 A, T _J =125 °C		100	135	mΩ	
	V _I = 3.3 V	I _O = 0.5 A		90	\25	11152	
		V _I = 3.3 V	$I_{O} = 0.5 \text{ A}, T_{J} = 85 ^{\circ}\text{C}$		110	:45	
		V _I = 3.3 V	I _O = 0.5 A, T _J = 125 °C		120	160	
+	Output rise time	$V_1 = 5.5 \text{ V}$	<	270	2.5		ms
t _r Output ri	Output rise time	$V_1 = 2.7 V$	B. = 10 C. = 1 uF		3		1113
+ 6	Output fall time	V _I = 5.5 V	$R_L = 10, C_L = 1 \text{ UF}$		0.3		ms
t _f	Output fall time	$V_1 = 2.7 \text{ V}$	-0/6		0.2		1113

Table 6. Enable Input ENx characteristics

Symbol	Parameter	Tost conditions	Min.	Тур.	Max.	Unit
V _{IH}	High level input voltage	1 / ₁ = 2.7 to 5.5 V	2			V
Low level input		V _I = 4.5 to 5.5 V			0.8	V
V_{IL}	voltag ;	V _I = 2.7 to 4.5 V			0.4	V
I _I	lı bui current	V _{IENX} = 0 V or V _I	-0.5		0.5	μΑ
ษัก	Turn-on time	R _L = 10 Ω, C _L = 100 μF			20	ms
t _{off}	Turn-off time	R_L = 10 Ω, C_L = 100 μF			40	ms
Table 7.	Current limit cha	aracteristics				

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ios		$V_I = 5$ V, OUT connected to GND, device enabled into short circuit	0.7	1	1.3	Α

Electrical characteristics ST2042

Table 8. Supply current characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SOL} Current low level output	Current low level	V _{IENX} = V _I , no load,		0.025	1	μА
	$V_{IENX} = V_I$, no load, $T_J = -40$ to 125 °C			10	μΑ	
, Current low high		V _{IENX} = 0, no load,		70	90	μА
I _{SOH} output	output	V _{IENX} = 0, no load, T _J = -40 to 125 °C			100	μΑ
ΙL	Output leakage current	$V_{IENX} = V_{I}$, output connected to GND, $T_{J} = -40$ to 125 °C			10	μА

Table 9. Undervoltage characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Ma'x.	'Jnit
V _{IL}	Low level input voltage		2	411	2.5	V
V _{HYS}	Hysteresis		(0	300		mV

Table 10. Overcurrent (OC) characteristics

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SINK}	Sink current	V _O = 5 V	10			mA
V _O	Output low voltage	I _O = 5 mA			0.5	٧
I _{OFF}	OFF-state current	$V_{O} = 5 \text{ V}, V_{O} = 3.3 \text{ V}$			1	μА
T _{FB}	Fault-blanking period	V _I - 5.5 V, T _J = 25 °C (See <i>Note 2</i> and <i>Note 3</i>)	2	10		ms

Note: 1 Pulse testing techniques maintain junction temperature close to ambient temperature: thermal official transfer by the takes into account separately.

- 2 Specified by design, not production tested.
- 3 Guaranteed by design.

Figure 3. Test circuit

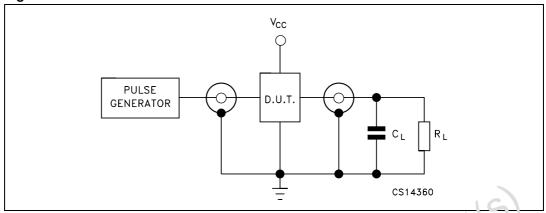
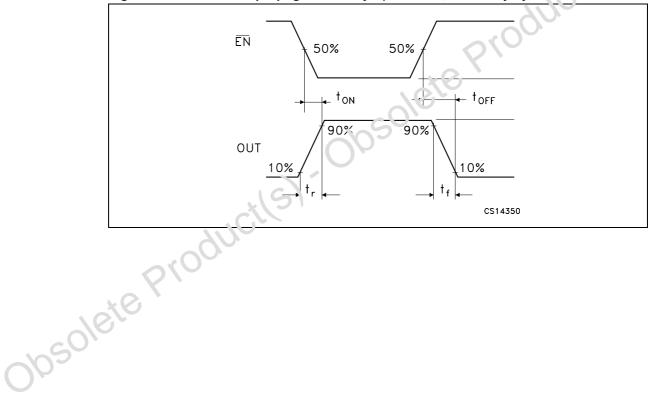


Figure 4. Waveform - propagation delays (f = 1 MHz; 50% duty cycle)



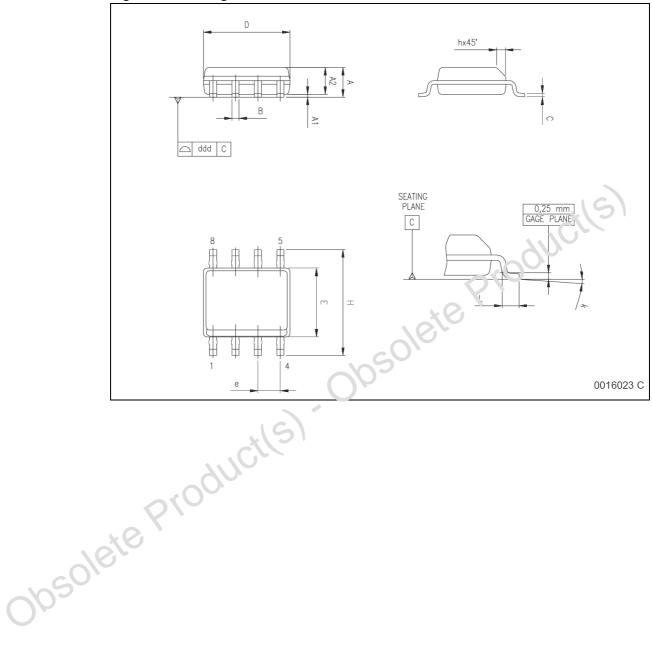
6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 11. SO-8 mechanical data

	Dim.		mm.			inch	
	Dim.	Min.	Тур.	Max.	Min.	Тур.	Max.
	Α	1.35		1.75	0.053		5.06.7
	A1	0.10		0.25	0.004	·C	0.010
	A2	1.10		1.65	0.043	AUT	0.065
	В	0.33		0.51	0.013	0	0.020
	С	0.19		0.25	0.007		0.010
	D	4.80		5.00	V. 189		0.197
	Е	3.80		4.00	0.15		0.157
	е		1.27	1050		0.050	
	Н	5.80		5.20	0.228		0.244
	h	0.25		0.50	0.010		0.020
	L	0.40	5	1.27	0.016		0.050
	k	·C)		8° (n	nax.)		
	ddd	YU		0.10			0.004
opsole	te Pr						

Figure 5. Package dimensions



Revision history ST2042

7 Revision history

Table 12. Revision history

	Date	Revision	Changes
	13-Jul-2005	4	Add bullet on pag. 1, add paragraph in the description on pag. 1 and add row T_{FB} on Table 10.
	29-May-2007	5	Updated features in cover page, document reformatted.
	24-Nov-2010	6	Document reformatted, added "Not Recommended for New Design" and <i>Note 1</i> below <i>Table 1</i> , corrected typo in <i>Features</i> , <i>Description</i> , <i>Figure 1</i> , <i>Table 2</i> to <i>Table 8</i> , <i>Table 10</i> , title of <i>Figure 4</i> , updated <i>Table 1</i> , <i>Section 4.1</i> , <i>Section 5</i> and ECOPACK® text in <i>Section 6</i> .
ECOPACK® text in Section 6.			

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